

SMT Adhesives



6609 SMT Adhesive	One component
6610 SMT Adhesive	One component
6611 SMT Adhesives	Screen Printing SMT Adhesives
6613 SMT Adhesives	Screen Printing SMT Adhesives



Tel/Fax: (+98) 711 227 2688
<http://www.pishrokhotoot.s5.com>
No.12-Bagh Safa building-Bagh
Safa Lane-Azadi Blvd-Shiraz-Iran

德邦®
Darbond

6609 SMT Adhesive

- One component, heat cure epoxy adhesive.
- General purpose.
- Designed for high speed SMT dispensing.
- Excellent heat resistance.
- Good storage stability.
- Bonding of surface mounted devices to PCB prior to wave soldering.

Package:	30ml/IEI tube	Item No. 660901
	30ml/EFD tube	Item No. 660902
	30ml/FUJI tube	Item No. 660903
	30ml/PANASERT tube	Item No. 660904
	30ml/cartridge	Item No. 660905



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6610 SMT Adhesive

- One component, heat cure epoxy adhesive.
- Fast cures at 120 °C
- Designed for stencil printing.
- Excellent adhesion.
- Good storage stability.
- Bonding of surface mounted devices to PCB prior to wave soldering.

Package:	30ml/IEI tube	Item No. 661001
	30ml/EFD tube	Item No. 661002
	30ml/FUJI tube	Item No. 661003
	30ml/PANASERT tube	Item No. 661004
	30ml/cartridge	Item No. 661005



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6611 SMT Adhesives

- One component, heat cure epoxy adhesive.
- General purpose.
- Designed for stencil printing.
- Excellent heat resistance.
- Good storage stability.
- Bonding of surface mounted devices to PCB prior to wave soldering.

Package: 200g/cartridge Item No. 661102
300ml/cartridge Item No. 661105



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6613 SMT Adhesives

- One component, heat cure epoxy adhesive.
- Fast cures at 120 °C
- Designed for stencil printing.
- Bonds difficult-to-bond devices.
- Excellent adhesion.
- Good storage stability.
- Bonding of surface mounted devices to PCB prior to wave soldering.

Package: 200g/cartridge Item No. 661302
 300ml/cartridge Item No. 661305



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PROPERTIES CHART

Product No.	Uncured			Cured				
	Color	Specific Gravity GB/T13354-1992 g/cm ³	Viscosity GB/T2794-1995 mPa.s	Hardness GB/T2411-1980 Shore D	Shear Strength GB/T7124-1986 MPa	Glass Transition Temperature ASTM E1545 °C	Dielectric Strength GB/T1408.1-1999 KV/mm	Surface Resistance GB/T1410-2006 Ω
6609	Red	1.22	1200	86	15.4	98	27	1.9×10 ¹⁵
6610	Red	1.22	1100	83	14.8	86	27	1.65×10 ¹⁵
6611	Red	1.24	1800	83	16.8	113	27	2.1×10 ¹⁵
6613	Red	1.28	1800	83	14.5	105	27	1.8×10 ¹⁵

Continued

Product No.	Cured						Recommended Curing Condition	
	Thrust N (DB6027)							
	3216 Device	Device 2125	Glass Diode	0603 Device	Tam-A Device	Device SOT	Temperature °C	Time sec
6609	67	46	35	-	-	-	150	60~90
6610	-	45	40	18	-	-	120	90~120
6611	-	-	35	-	61	54	150	60~90
6613	-	-	40	-	63	52	120	90~120